



Device = LM3478MM
Topology = Boost
Created = 4/25/12 6:00:19 AM
BOM Cost = \$5.51
Total Pd = 7.55 W
Footprint = 2,013.0 mm2
BOM Count = 23

#	Name	Manufacturer	Part Number	Quantity	Price	Properties	Footprint
7.	D1	Vishay-Semiconductor	12CWQ10FNPBF	1	\$0.69	VF@Io= 950.0 mV VRRM= 100.0 V	 DPAK 102mm2
8.	L1	Coilcraft	XAL1010-153MEB	1	\$1.08	L= 15.0 µH DCR= 20.0 mOhm	 XAL1010 160mm2
9.	M1	Infineon Technologies	BSZ105N04NS G	1	\$0.30	VdsMax= 40.0 V IdsMax= 40.0 Amps	 PG-TSDSON-8 29mm2
10.	Rcomp	Vishay-Dale	CRCW04029K53FKED Series= CRCW..e3	1	\$0.01	Res= 9.53 kOhm Power= 63.0 mW Tolerance= 1.0%	 0402 8mm2
11.	Rfadj	Vishay-Dale	CRCW040288K7FKED Series= CRCW..e3	1	\$0.01	Res= 88.7 kOhm Power= 63.0 mW Tolerance= 1.0%	 0402 8mm2
12.	Rfb1	Vishay-Dale	CRCW04021K00FKED Series= CRCW..e3	1	\$0.01	Res= 1,000 Ohm Power= 63.0 mW Tolerance= 1.0%	 0402 8mm2
13.	Rfb2	Vishay-Dale	CRCW040224K3FKED Series= CRCW..e3	1	\$0.01	Res= 24.3 kOhm Power= 63.0 mW Tolerance= 1.0%	 0402 8mm2
14.	Rs1	Vishay-Dale	CRCW0402100RFKED Series= CRCW..e3	1	\$0.01	Res= 100.0 Ohm Power= 63.0 mW Tolerance= 1.0%	 0402 8mm2
15.	Rsense	Panasonic	ERJ-M1WSF10MU Series= 1119	1	\$0.15	Res= 10.0 mOhm Power= 1.0 W Tolerance= 1.0%	 2512 43mm2
16.	U1	Texas Instruments	LM3478MM	1	\$0.93	Switcher	 MUA08A 34mm2

Operating Values

#	Name	Value	Category	Description
1.	Cin IRMS	606.545 m A	Current	Input capacitor RMS ripple current
2.	Cout IRMS	3.14 A	Current	Output capacitor RMS ripple current
3.	Iin Avg	6.981 A	Current	Average input current
4.	L Ipp	2.101 A	Current	Peak-to-peak inductor ripple current
5.	L1 Irms	6.897 A	Current	Inductor ripple current
6.	M Irms	6.575 A	Current	MOSFET RMS ripple current
7.	SW Ipk	7.921 A	Current	Peak switch current
8.	BOM Count	23.0	General	Total Design BOM count
9.	FootPrint	2.013 k mm2	General	Total Foot Print Area of BOM components
10.	Frequency	209.831 k Hz	General	Switching frequency
11.	IC Tolerance	24.3 m V	General	IC Feedback Tolerance
12.	M Rdson	11.76 m Ohm	General	Drain-Source On-resistance
13.	M Vds Act	77.319 m V	General	M Vds
14.	Mode	CCM	General	Conduction Mode
15.	Pout	160.0 W	General	Total output power
16.	Total BOM	\$5.51	General	Total BOM Cost
17.	D1 Tj	82.25 degC	Op_Point	D1 junction temperature
18.	Vout OP	32.0 V	Op_Point	Operational Output Voltage
19.	Cross Freq	4.113 k Hz	Op_point	Bode plot crossover frequency
20.	Duty Cycle	28.383 %	Op_point	Duty cycle
21.	Efficiency	95.492 %	Op_point	Steady state efficiency
22.	IC Tj	65.034 degC	Op_point	IC junction temperature
23.	ICThetaJA	200.0 degC/W	Op_point	IC junction-to-ambient thermal resistance
24.	IOUT_OP	5.0 A	Op_point	Iout operating point
25.	M ThetaJA	60.0 degC/W	Op_point	MOSFET junction-to-ambient thermal resistance
26.	M TjOp	82.933 degC	Op_point	MOSFET junction temperature
27.	Phase Marg	57.962 deg	Op_point	Bode Plot Phase Margin
28.	VIN_OP	24.0 V	Op_point	Vin operating point
29.	Vout p-p	78.792 m V	Op_point	Peak-to-peak output ripple voltage
30.	Cin Pd	55.184 m W	Power	Input capacitor power dissipation
31.	Cout Pd	369.712 m W	Power	Output capacitor power dissipation

#	Name	Value	Category	Description
32.	Diode Pd	4.75 W	Power	Diode power dissipation
33.	IC Pd	175.17 m W	Power	IC power dissipation
34.	L Pd	1.142 W	Power	Inductor power dissipation
35.	M Pd	882.221 m W	Power	MOSFET power dissipation
36.	M1 PdCond	642.651 m W	Power	M1 MOSFET conduction losses
37.	M1 PdSw	239.57 m W	Power	M1 MOSFET switching losses
38.	Rfb Pd	40.474 m W	Power	Rfb Power Dissipation
39.	Total Pd	7.553 W	Power	Total Power Dissipation

Design Inputs

#	Name	Value	Description
1.	Iout	5.0 A	Maximum Output Current
2.	Iout1	5.0 Amps	Output Current #1
3.	VinMax	26.0 V	Maximum input voltage
4.	VinMin	24.0 V	Minimum input voltage
5.	Vout	32.0 V	Output Voltage
6.	Vout1	32.0 Volt	Output Voltage #1
7.	base_pn	LM3478	Texas Instruments base part number
8.	Ta	30.0 degC	Ambient temperature

Design Assistance

1. **LM3478** Product Folder : <http://www.ti.com/product/LM3478> : contains the data sheet and other resources.

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